

Title (en)  
APPARATUS AND PROCESS FOR CUTTING ADHESIVE LABELS

Title (de)  
VORRICHTUNG UND VERFAHREN ZUM SCHNEIDEN VON SELBSTKLEBENDEN AUFKLEBERN

Title (fr)  
APPAREIL ET PROCÉDÉ DE DÉCOUPAGE D'ÉTIQUETTES ADHÉSIVES

Publication  
**EP 2323821 A2 20110525 (EN)**

Application  
**EP 09790388 A 20090714**

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Abstract (en)  
[origin: WO2010009102A2] A method and apparatus are provided for die cutting label stock comprising a facestock, an adhesive and optionally a liner to form labels where a liner of the lined pressure sensitive adhesive label stock may be a thin or ultrathin liner.

IPC 8 full level  
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**Y10T 83/283** (2015.04 - EP US); **Y10T 156/1994** (2015.01 - EP US)

Citation (search report)  
See references of WO 2010009102A2

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CA 2749388 C 20170228; CN 102149521 A 20110810; CN 106166763 A 20161130; CO 6331455 A2 20111020; EP 2323821 A2 20110525;  
EP 2323821 B1 20170426; JP 2011527950 A 20111110; JP 2015013477 A 20150122; JP 6077494 B2 20170208; KR 101739242 B1 20170523;  
KR 20110036834 A 20110411; KR 20160062134 A 20160601; MX 2011000615 A 20110405; MX 337188 B 20160216; PL 2323821 T3 20170929;  
RU 2011103722 A 20120820; RU 2478038 C2 20130327; US 2011132522 A1 20110609; US 2013091999 A1 20130418;  
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CN 200980135807 A 20090714; CN 201610454823 A 20090714; CO 11003667 A 20110114; EP 09790388 A 20090714;  
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